

POWER MOSFET

24A, 60V N-CHANNEL POWER MOSFET

DESCRIPTION

The UTC **UT24N06** is a N-channel enhancement MOSFET using UTC's advanced technology to provide the customers with perfect $R_{DS(ON)}$ and high switching speed.

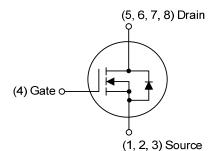
The UTC **UT24N06** is suitable for all commercial-industrial applications at power dissipation levels to approximately 50 watts, etc.

FEATURES

- * $R_{DS(ON)} \le 24m\Omega$ @ $V_{GS}=10V$, $I_D=12A$
- $R_{DS(ON)} \le 33m\Omega @ V_{GS}=4.5V, I_D=12A$
- * High Switching Speed

SOP-8

SYMBOL



ORDERING INFORMATION

Ordering Number			Daakaga	Pin Assignment								Dooking	
Lead Free H		Halogen Free	Package	1	2	3	4	5	6	7	8	Packing	
UT24N06L-S08-R UT24N06G-S08-R			SOP-8	S	S	S	G	D	D	D	D	Tape Reel	
Note: Pin Assignmer	Note: Pin Assignment: S: Source G: Gate D: Drain												
UT24N06 <u>G-S0</u>	(1) R: Tape Reel (2) S08: SOP-8												
(3) Green Package (3) G: Halogen Free and Lead Free													
MARKING Image: Constraint of the set of th													
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■ **ABSOLUTE MAXIMUM RATING** (T_c=25°C, unless otherwise specified)

	,			
PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	60	V
Gate-Source Voltage		V _{GSS}	±20	V
Drain Current	Continuous	I _D	24	Α
Drain Current	Pulsed (Note 2)	I _{DM}	48	Α
Single Pulse Avalanche Energy		E _{AS}	32.3	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.8	V/ns
Power Dissipation		PD	6.25	W
Junction Temperature		ТJ	+150	°C
Storage Temperature Range		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3. L=0.1mH, I_{AS} =25.4A, V_{DD} =50V, R_G =25 Ω , Starting T_J = 25°C

4. $I_{SD} \le 25.4A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ _{JA}	62.5	°C/W
Junction to Case	θ _{JC}	20	°C/W

Note: The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

■ ELECTRICAL CHARACTERISTICS (T_J = 25°C, unless otherwise specified)

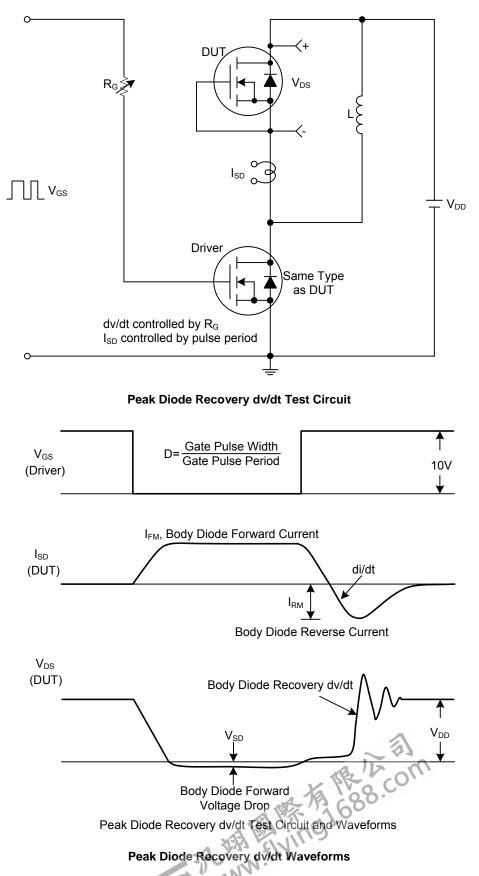
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							-
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μΑ, V _{GS} =0V	60			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =60V, V _{GS} =0V			1	μA
	Forward		V _{GS} =+20V, V _{DS} =0V			+100	nA
Gate-Source Leakage Current	Reverse	I _{GSS}	V _{GS} =-20V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250µA	1.0		3.0	V
Static Drain-Source On-State Resistance			V _{GS} =10V, I _D =12A			24	mΩ
		R _{DS(ON)}	V _{GS} =4.5V, I _D =12A			33	mΩ
DYNAMIC PARAMETERS							
Input Capacitance		CISS			866		рF
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		96		рF
Reverse Transfer Capacitance		C _{RSS}			83		рF
SWITCHING PARAMETERS					-		
Total Gate Charge (Note 1)		Q_{G}	V _{DS} =30V, V _{GS} =10V, I _D =24A,		27		nC
Gate to Source Charge		Q_{GS}	I_{G} =1mA (Note 1, 2)		3		nC
Gate to Drain Charge		Q_{GD}			5.2		nC
Turn-on Delay Time (Note 1)		t _{D(ON)}			10		ns
Rise Time		t _R	V _{DD} =30V, V _{GS} =10V, I _D =24A,		18		ns
Turn-off Delay Time		t _{D(OFF)}	R _G =3.3Ω (Note 1, 2)		38		ns
Fall-Time		t _F	3	19		ns	
SOURCE- DRAIN DIODE RATING	SS AND CH	ARACTERIST	rics	0	-		
Maximum Body-Diode Continuous	Current	ls	KR CON			24	Α
Maximum Body-Diode Pulsed Curr	rent	I _{SM}	4 18 690.			48	А
Drain-Source Diode Forward Volta	ge (Note 1)	V _{SD}	I ₈ =24A, V _{GS} =0V			1.4	V
Reverse Recovery Time (Note 1)		t _{rr}	I _S =24A, V _{GS} =0V,		88		nS
Reverse Recovery Charge		Qrr	dl⊧/dt =100A/µs		77		nC
Notoo: 1. Dulas Test : Dulas width							

Notes: 1. Pulse Test : Pulse width \leq 300µs, Duty cycle \leq 2%.

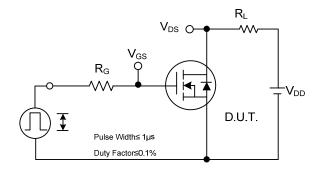
2. Essentially independent of operating ambient temperature.

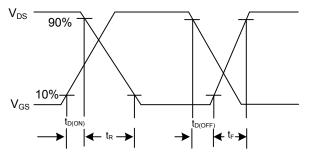
UNISONIC TECHNOLOGIES CO., LTD

TEST CIRCUITS AND WAVEFORMS

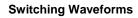


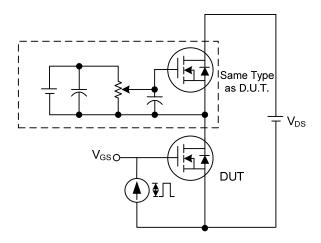
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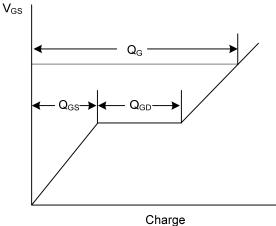




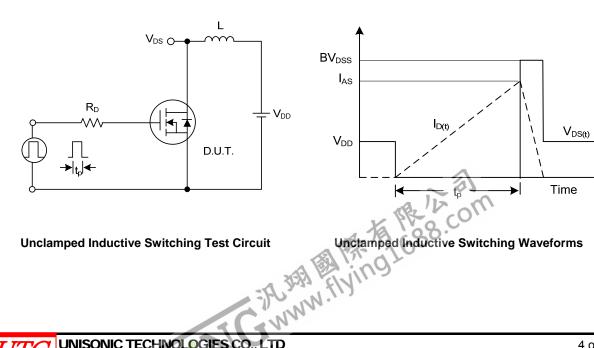




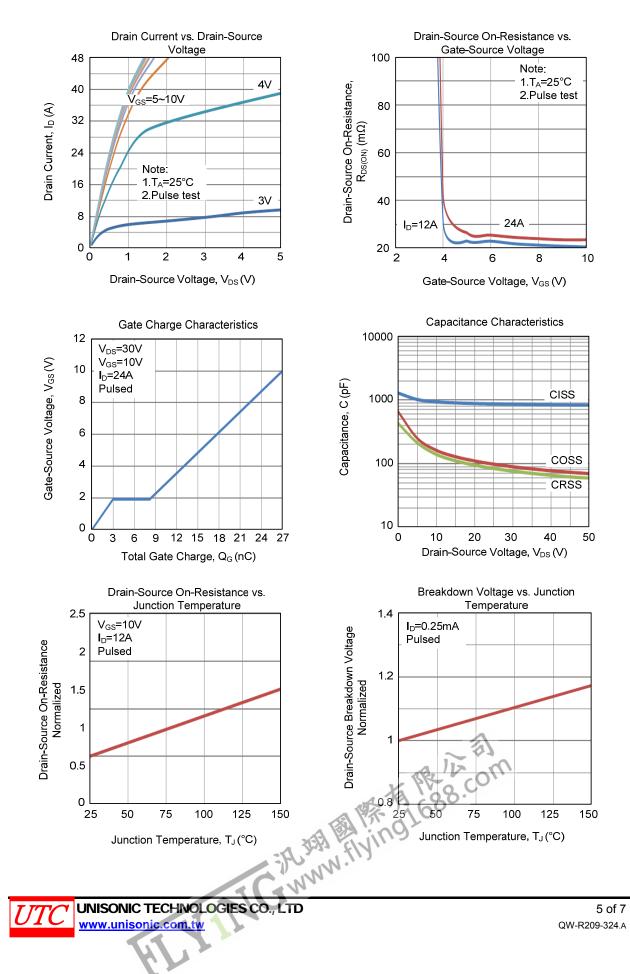
Gate Charge Test Circuit



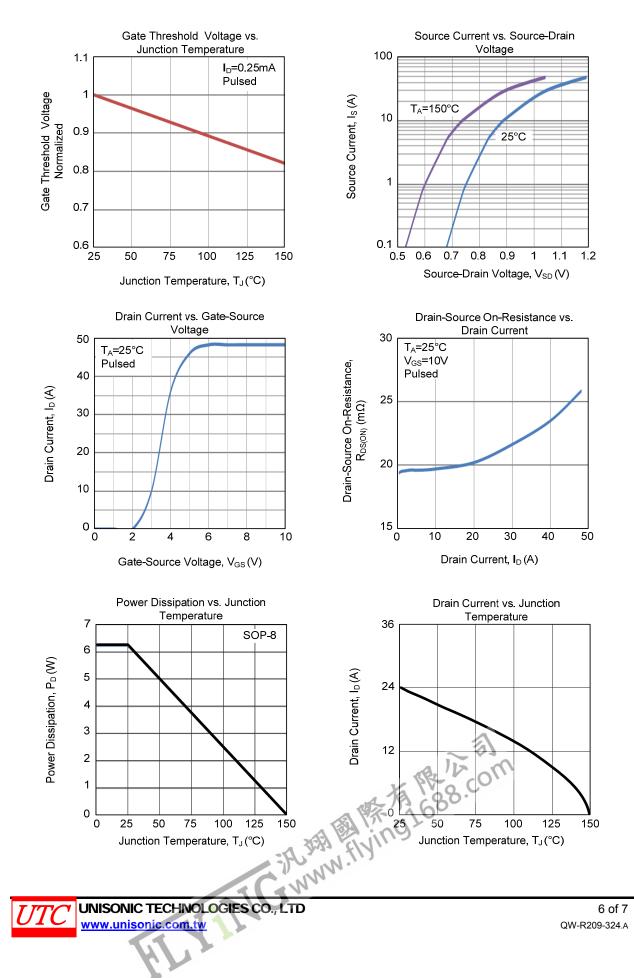




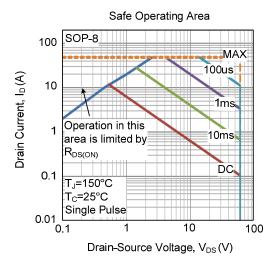
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (Cont.)



TYPICAL CHARACTERISTICS (Cont.)



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